## Bill of Materials

TI DESIGNS

TIDA-00317

	ltem	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer	Alternate Part	PCB Footprint	Note
							Part Number			
	1	1	J1		Header, 50mil, 10x1, Tin, Through Hole	Preci-Dip	850-80-010-10-001101			

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